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Electronic Patent Application Submission  
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EFS ID: 60530

Application ID: 10626150



Title of Invention:

PLASTIC INTEGRATED CIRCUIT  
PACKAGE AND METHOD AND  
LEADFRAME FOR MAKING THE  
PACKAGE

First Named Inventor: THOMAS GLENN

Domestic/Foreign Application: Domestic Application

Filing Date: 2003-07-24

Effective Receipt Date: 2004-05-06

Submission Type: Information Disclosure

Filing Type:

Confirmation number: 9302

Attorney Docket Number: .AMKOR007C2

Total Fees Authorized:

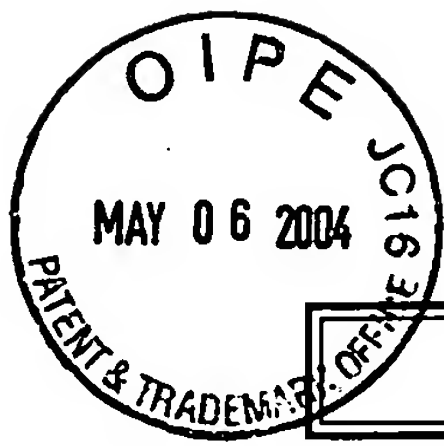
Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark  
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**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>PLASTIC INTEGRATED CIRCUIT PACKAGE AND METHOD AND LEADFRAME FOR MAKING THE PACKAGE</b>									
Application Number: 10/626150 Date: 2003-07-24 First Named Applicant: THOMAS P.  Confirmation Number: 9302 Attorney Docket Number: AMKOR007C2										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
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MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td><b>Documents being submitted</b></td><td><b>Files</b></td></tr><tr><td>us-ids</td><td>ids6-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			<b>Documents being submitted</b>	<b>Files</b>	us-ids	ids6-usidst.xml		us-ids.dtd		us-ids.xsl
<b>Documents being submitted</b>	<b>Files</b>									
us-ids	ids6-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
<b>Comments</b>										



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

### Title of Invention

PLASTIC INTEGRATED CIRCUIT PACKAGE AND  
AND LEADFRAME FOR MAKING THE PACKAGE

Application Number: 10/626150  
Confirmation Number: 9302  
First Named Applicant: THOMAS GLENN  
Attorney Docket Number: AMKOR007C2  
Art Unit: 2815  
Search string: ( 6348726 or 6355502 or 6369447 or 6369454 or  
6373127 or 6380048 or 6384472 or 6388336 or  
6395578 or 6410979 or 6400004 or 6414385 or  
6420779 or 6429508 or 6437429 or 6444499 or  
6448633 or 6452279 or 6459148 or 6464121 or  
6476469 or 6476474 or 6482680 or 6498099 or  
6498392 or 6507096 or 6507120 or 6534849 or  
6545332 or 6545345 or 6559525 or 6566168 or  
6583503 or 6667546 ).pn.

### US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	34	6667546	2003-12-23	Huang et al.

Signature

Examiner Name	Date